



Pin Assignments

GND 2

NC 1

GND 2

AH1809

LOW SENSITIVITY MICROPOWER OMNIPLOAR HALL-EFFECT SWITCH

3

1 V_{DD}

5 OUTPUT

OUTPUT

Description

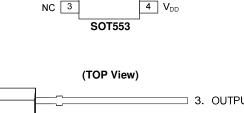
The AH1809 is a low sensitivity micropower Omnipolar Hall Effect switch IC. It is designed for battery powered consumer products, home appliances, and industrial equipment such smart e-meters. Based on two Hall Effect plates and a chopper stabilized architecture the AH1809 provides a reliable solution over the whole operating range. To support battery and low power applications the design has been optimized to operate over the supply range of 2.5V to 5.5V and consumes only 24μ W with a supply of 3V.

The single open drain output can be switched on with either a North or South pole of sufficient strength. When the magnetic flux density perpendicular to the package (B) is larger than operate point (Bop), the output is switched on (pulled low). The output is turned off when B becomes lower than the release point (Brp). The output will remain off when there is no magnetic field.

The AH1809 is available in SC59, SOT553 and SIP-3L.

Features

- Omnipolar (North or South pole) Operation
- Low Sensitivity
- Single Open Drain Output
- Micropower Operation
- 2.5V to 5.5V Operating Range
- Chopper Stabilized Design Provides
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Stress
- Good RF Noise Immunity
- -40 ℃ to +125 ℃ Operating Temperature
- High ESD
- Small Low Profile SOT553 and Industry Standard SC59 and SIP-3L Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)



TOP View)

SC59

(TOP View)



Applications

- Smart E-Meters
- Tamper Protection Switch
- Door, Lids and Tray Position Switch
- Proximity and Position Switches
- Level Detects
- On/Off Switch Digital Contact-Less Switch in Industrial and Consumer Products

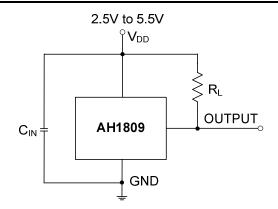
Notes: 1

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Typical Applications Circuit



Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor, the recommended resistance is 10k Ω to 100k Ω .

Pin Descriptions

Package: SC59 and SIP-3L

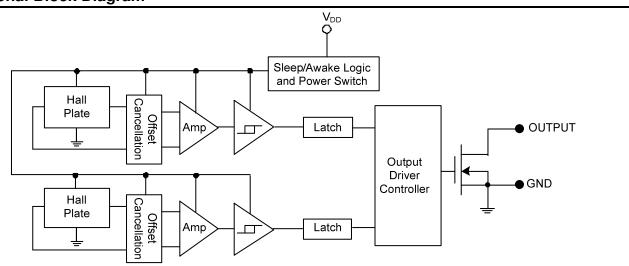
Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Package: SOT553

Pin Number	Pin Name	Function			
1	NC	No Connection (Note 5)			
2	GND	Ground			
3	NC	No Connection (Note 5)			
4	V _{DD}	Power Supply Input			
5	OUTPUT	Output			

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

Functional Block Diagram





Absolute Maximum Ratings (Note 6) (@TA = +25 °C, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
V _{DD}	Supply Voltage (Note 7)		7	V
V _{OUT}	Output Pin Voltage (Note 7)		7	V
V _{DD REV}	Reverse Supply Voltage		-0.3	V
V _{OUT_REV}	Reverse Output Pin Voltage		-0.3	V
IOUTPUT	Output current (source and sink)	2.5	mA	
В	Magnetic Flux Density		Unlimited	
D	Deskage Dewer Dissingtion	SC59 and SOT553	230	mW
PD	Package Power Dissipation	SIP-3L	230	_
Ts	Storage Temperature Range	-65 to +150	°C	
TJ	Maximum Junction Temperature		+150	°C
ESD HBM	Human Body Model ESD capability		6	kV

6. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
7. The absolute maximum V_{DD} of 7V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time. Notes:

Recommended Operating Conditions (@TA = +25 °C, unless otherwise specified.)

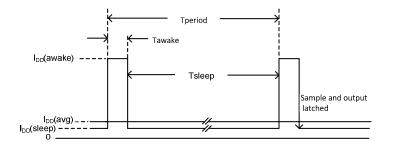
Symbol	Parameter Conditions		Rating	Unit
V _{DD}	Supply Voltage	Operating	2.5 to 5.5	V
V _{OUT_MAX}	Maximum output pin voltage	Operating	5.5	V
TA	Operating Temperature Range	Operating	-40 to +125	°C

Electrical Characteristics (@T_A = +25 °C, VDD = 3V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
V _{OUT_ON}	Output On Voltage (V _{OL})	I _{OUT} = 1mA	—	0.1	0.3	V	
loff	Output Leakage Current	$V_{OUT} = 5.5V$, Output off	—	< 0.1	1	μΑ	
l (auglia)		During 'awake' period, T _A = +25 °C, V _{DD} = 3V	_	3	6	mA	
I _{DD} (awake)		During 'awake' period, $T_A = -40$ to $+125$ °C, V _{DD} = 2.5V to 5.5V		_	_	12	mA
I _{DD} (sleep)	- Supply Current	During 'sleep' period, T _A = +25 °C, V _{DD} = 3V	_	5	10	μA	
I _{DD} (sleep)		During 'sleep' period, T _A = -40 to +125 °C, V _{DD} = 2.5V to 5.5V	_	—	28	μA	
(aa)	Average Supply Current	T _A = +25°C, V _{DD} = 3V	—	8	16	μA	
I _{DD} (avg)	Average Supply Current	$T_A = -40$ to $+125 ^{\circ}\text{C}$, $V_{DD} = 2.5V$ to $5.5V$	—	_	40	μA	
Tawake	Awake Time	(Note 8)	_	75	125	μs	
Tperiod	Period	(Note 8)	_	75	125	ms	
D.C.	Duty Cycle	-	—	0.1	_	%	

Note: 8. When power is initially turned on, the operating V_{DD} must be within its correct operating range (2.5V to 5.5V) to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 150ms).



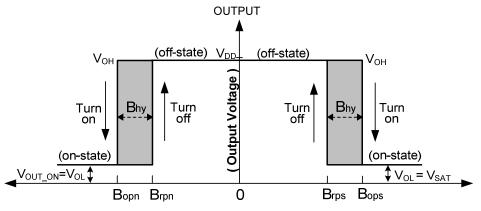


Magnetic Characteristics (Notes 9 & 10) (T_A = +25 °C, V_{DD} = 2.5V to 5.5V, unless otherwise specified.)

					(1mT=10 0	Gauss)
Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
Bops (south pole to part marking side)		T _A = +25 ℃	100	130	165	
Bops (south pole to part marking side)	Operation Point	T _A = -40 °C to +125 °C	90	130	185	
Bopn (north pole to part marking side)	Operation Follit	T _A = +25 ℃	-165	-130	-100	
		T _A = -40 °C to +125 °C	-185	-130	-90	
Drag (aguth pale to part marking side)		T _A = +25 ℃	90	115	150	Course
Brps (south pole to part marking side)	Release Point	T _A = -40 °C to +125 °C	80	115	170	Gauss
	Release Point	T _A = +25 ℃	-150	-115	-90	
Brpn (north pole to part marking side)		T _A = -40 °C to +125 °C	-170	-115	-80	
	Libratovacia (Nista 11)	T _A = +25 ℃	10	15	20	
Bhy (Bopx - Brpx)	Hysteresis (Note 11)	T _A = -40 °C to +125°C	5	15	—	

Notes: 9. Typical data is at T_A = +25 °C, V_{DD} = 3V.

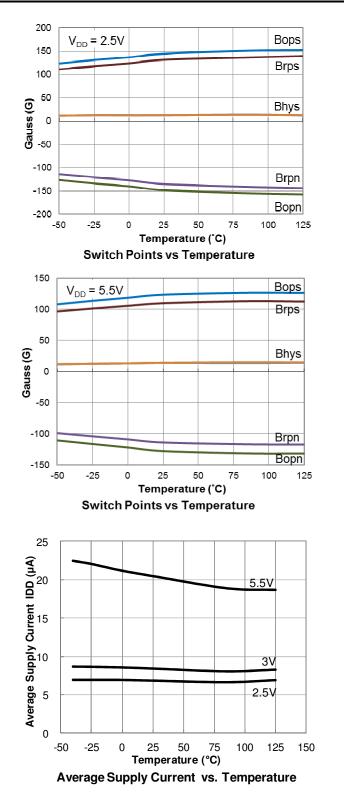
Parameters values over operating temperature range are not tested in production, they are guaranteed by design, process control and characterization. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.
 Maximum and minimum hysteresis is guaranteed by design and characterization.

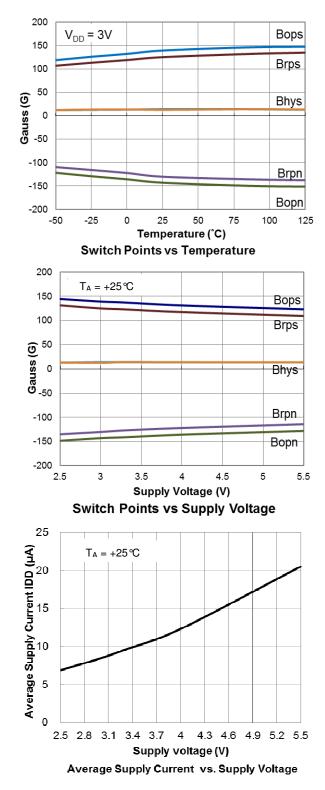






Typical Operating Characteristics





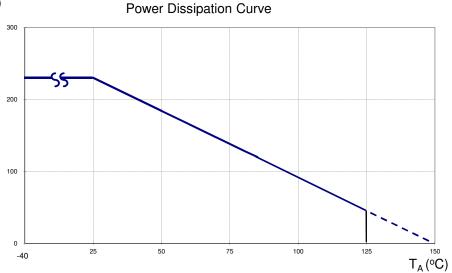


Thermal Performance Characteristics

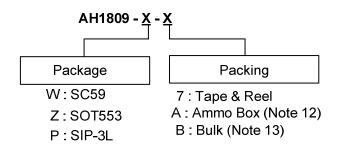
(1) Package type: SC59, SOT553 and SIP-3L

T _A (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0

PD (mW)



Ordering Information



		Bulk 7" Tape and Reel		Reel	Ammo Box			
Part Number	Package Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH1809-W-7	Z	SC59	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH1809-Z-7	Z	SOT553	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH1809-P-B	Р	SIP-3L	1000	-В	NA	NA	NA	NA
AH1809-P-A	Р	SIP-3L	NA	NA	NA	NA	4,000/Box	-A

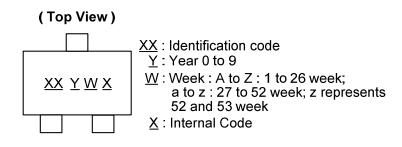
Notes: 12. Ammo Box is for SIP-3L Spread Lead.

13. Bulk is for SIP-3L Straight Lead.



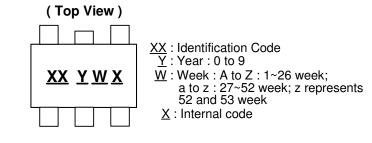
Marking Information

(1) Package Type: SC59



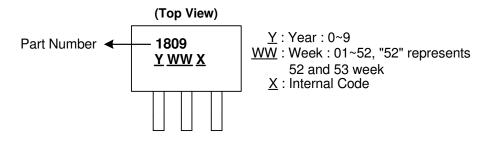
Part Number	Package	Identification Code	
AH1809	SC59	F9	

(2) Package Type: SOT553



Part Number	Package	Identification Code		
AH1809	SOT553	H9		

(3) Package Type: SIP-3L

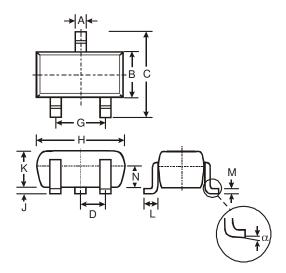




Package Outline Dimensions (All dimensions in mm.)

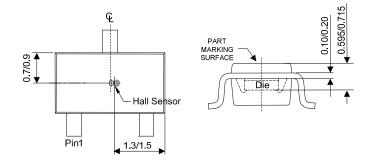
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(1) Package Type: SC59



	SC	59	
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
в	1.50	1.70	1.60
С	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
к	1.00	1.30	1.10
L	0.35	0.55	0.40
М	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All	Dimens	ions in	mm

Min/Max



Sensor Location



Тур

0.60

0.20

0.15

1.60

1.60

1.20

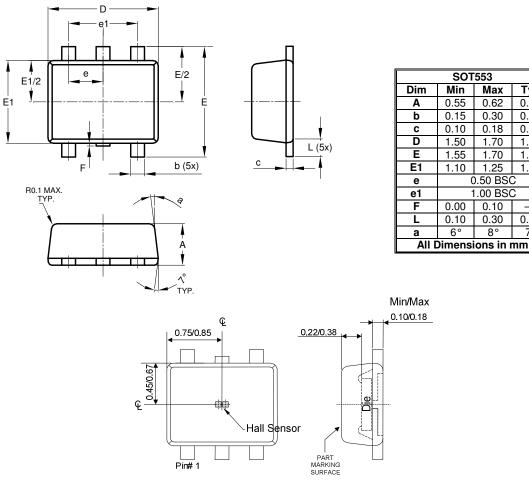
0.20

7°

Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(2) Package Type: SOT553



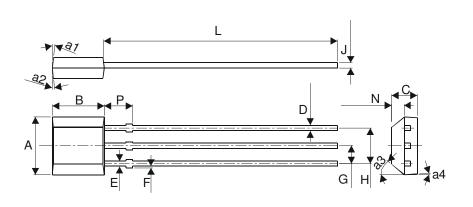
Sensor Location



Package Outline Dimensions (cont.) (All dimensions in mm.)

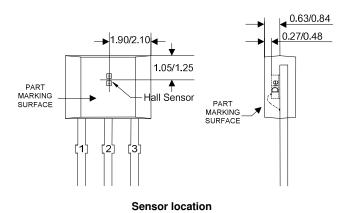
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(3) Package Type: SIP-3L for Bulk Pack



SIP-3	SIP-3 for Bulk Pack						
Dim	Min	Max					
Α	3.9	4.3					
a1	5°	Тур					
a2	5°	Тур					
a3	45 °	° Тур					
a4	3°	Тур					
В	2.8	3.2					
C	1.40	1.60					
D	0.33	0.432					
Е	0.40	0.508					
F	0	0.2					
G	1.24	1.30					
H	2.51	2.57					
ر	0.35	0.43					
L	14.0	15.0					
N	0.63	0.84					
Р	1.55	-					
All Dir	nension	s in mm					

Min/Max

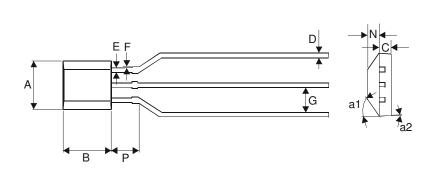




Package Outline Dimensions (cont.) (All dimensions in mm.)

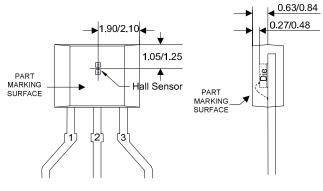
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(4) Package Type: SIP-3L for Ammo Pack



SIP-3			
for Ammo Pack only			
Dim	Min	Max	
Α	3.9	4.3	
a1	45° Typ		
a2	3° Тур		
в	2.8	3.2	
С	1.40	1.60	
D	0.35	0.41	
Е	0.43	0.48	
F	0	0.2	
G	2.4	2.9	
N	0.63	0.84	
Р	1.55	-	
All Dimensions in mm			





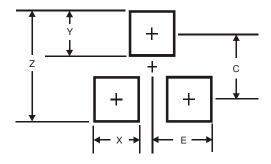
Sensor location



Suggested Pad Layout

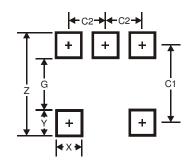
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1
С	2.4
E	1.35

(2) Package Type: SOT553



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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